



High-end Power Semiconductor Manufacturer

KP1600A 3500V-4400V Phase Control Thyristor

- High power cycling capability
- Low on-state and switching losses
- Designed for traction and industrial applications



Mean on-state current	I_{TAV}		1600 A	
Repetitive peak off-state voltage	V_{DRM}		3500 – 4400 V	
Repetitive peak reverse voltage	V_{RRM}			
Turn-off time	t_q		500 μ s	
V_{DRM}, V_{RRM}, V	3500	4000	4200	4400
Voltage code	35	40	42	44
$T_j, ^\circ C$	– 60 – 125			

MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions
ON-STATE				
I_{TAV}	Mean on-state current	A	1600	$T_c=85^\circ C$, Double side cooled 180° half-sine wave; 50 Hz
I_{TRMS}	RMS on-state current	A	2512	$T_c=85^\circ C$, Double side cooled 180° half-sine wave; 50 Hz
I_{TSM}	Surge on-state current	kA	39.0 45.0	$T_j=T_{jmax}$ $T_j=25^\circ C$ 180° half-sine wave; 50 Hz ($t_p=10$ ms); single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=I_{FGM}$; $V_G=20$ V; $t_{GP}=500$ μ s; $di_G/dt=1$ A/ μ s
			41.0 47.0	$T_j=T_{jmax}$ $T_j=25^\circ C$ 180° half-sine wave; 60 Hz ($t_p=8.3$ ms); single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=I_{FGM}$; $V_G=20$ V; $t_{GP}=500$ μ s; $di_G/dt=1$ A/ μ s
I^2t	Safety factor	A^2s	7.605×10^6 10.125×10^6	$T_j=T_{jmax}$ $T_j=25^\circ C$ 180° half-sine wave; 50 Hz ($t_p=10$ ms); single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=I_{FGM}$; $V_G=20$ V; $t_{GP}=500$ μ s; $di_G/dt=1$ A/ μ s
			6.975×10^6 9.165×10^6	$T_j=T_{jmax}$ $T_j=25^\circ C$ 180° half-sine wave; 60 Hz ($t_p=8.3$ ms); single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=I_{FGM}$; $V_G=20$ V; $t_{GP}=500$ μ s; $di_G/dt=1$ A/ μ s
BLOCKING				
V_{DRM}, V_{RRM}	Repetitive peak off-state and Repetitive peak reverse voltages	V	3500–4400	$T_{jmin} < T_j < T_{jmax}$; 180° half-sine wave; 50 Hz; Gate open
V_{DSM}, V_{RSM}	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	3600–4500	$T_{jmin} < T_j < T_{jmax}$; 180° half-sine wave; 50 Hz; single pulse; Gate open
V_D, V_R	Direct off-state and Direct reverse voltages	V	$0.75 \cdot V_{DRM}$ $0.75 \cdot V_{RRM}$	$T_j=T_{jmax}$; Gate open

TRIGGERING				
P_{GM}	Peak forward gate power	W	40	$T_j = T_{j\max}$
V_{RGM}	Peak reverse gate voltage	V	5	
P_G	Gate power dissipation	W	5	$T_j = T_{j\max}$ for DC gate current
SWITCHING				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive ($f=1$ Hz)	A/ μ s	800	$T_j = T_{j\max}$; $V_D = 0.67 \cdot V_{DRM}$; $I_{TM} = 2 I_{TAV}$; Gate pulse: $I_G = I_{FGM}$; $V_G = 20$ V; $t_{GP} = 500 \mu$ s; $di_G/dt = 1$ A/ μ s
THERMAL				
T_{stg}	Storage temperature	$^{\circ}$ C	-60 – 125	
T_j	Operating junction temperature	$^{\circ}$ C	-60 – 125	
MECHANICAL				
F	Mounting force	kN	40.0 – 50.0	
a	Acceleration	m/s ²	50 100	Device unclamped Device clamped

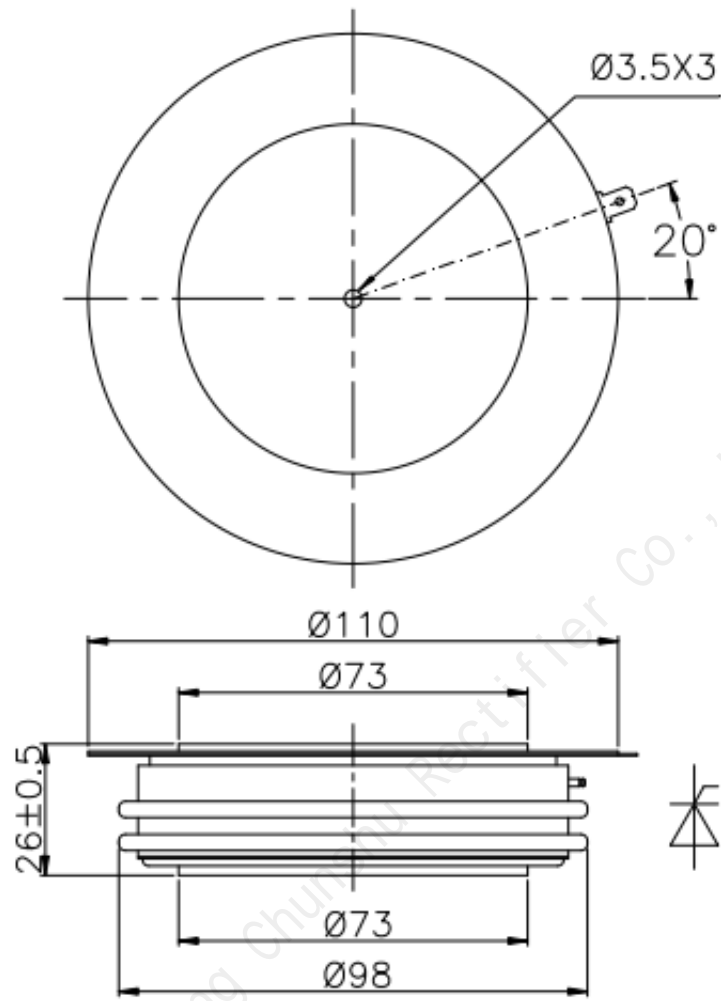
CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions
ON-STATE				
V_{TM}	Peak on-state voltage, max	V	2.15	$T_j = 25$ $^{\circ}$ C; $I_{TM} = 5024$ A
$V_{T(TO)}$	On-state threshold voltage, max	V	1.20	$T_j = T_{j\max}$;
r_T	On-state slope resistance, max	m Ω	0.250	$0.5 \pi I_{TAV} < I_T < 1.5 \pi I_{TAV}$
I_L	Latching current, max	mA	10000	$T_j = 25$ $^{\circ}$ C; $V_D = 12$ V; Gate pulse: $I_G = I_{FGM}$; $V_G = 20$ V; $t_{GP} = 500 \mu$ s; $di_G/dt = 1$ A/ μ s
I_H	Holding current, max	mA	1000	$T_j = 25$ $^{\circ}$ C; $V_D = 12$ V; Gate open
BLOCKING				
I_{DRM} , I_{RRM}	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	300	$T_j = T_{j\max}$; $V_D = V_{DRM}$; $V_R = V_{RRM}$
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage ¹⁾ , min	V/ μ s	1000	$T_j = T_{j\max}$; $V_D = 0.67 \cdot V_{DRM}$; Gate open
TRIGGERING				
V_{GT}	Gate trigger direct voltage, max	V	3.00 2.00	$T_j = 25$ $^{\circ}$ C $T_j = T_{j\max}$ $V_D = 12$ V; $I_D = 3$ A; Direct gate current
I_{GT}	Gate trigger direct current, max	mA	300 200	$T_j = 25$ $^{\circ}$ C $T_j = T_{j\max}$
V_{GD}	Gate non-trigger direct voltage, min	V	0.35	$T_j = T_{j\max}$; $V_D = 0.67 \cdot V_{DRM}$;
I_{GD}	Gate non-trigger direct current, min	mA	15.0	Direct gate current
SWITCHING				
t_{gd}	Delay time	μ s	3.00	$T_j = 25$ $^{\circ}$ C; $V_D = 0.4 \cdot V_{DRM}$; $I_{TM} = I_{TAV}$; Gate pulse: $I_G = I_{FGM}$; $V_G = 20$ V; $t_{GP} = 500 \mu$ s; $di_G/dt = 1$ A/ μ s
t_q	Turn-off time ²⁾ , max	μ s	500	$dv_D/dt = 50$ V/ μ s; $T_j = T_{j\max}$; $I_{TM} = 1600$ A; $di_R/dt = -10$ A/ μ s; $V_R = 100$ V; $V_D = 0.67 \cdot V_{DRM}$
Q_{rr}	Total recovered charge, max	μ C	5000	$T_j = T_{j\max}$; $I_{TM} = 1600$ A ;
t_{rr}	Reverse recovery time, max	μ s	63	$di_R/dt = -5$ A/ μ s ;
I_{rrM}	Peak reverse recovery current, max	A	160	$V_R = 100$ V

THERMAL					
R_{thjc}	Thermal resistance, junction to case, max	°C/W	0.0085	Direct current	Double side cooled
R_{thjc-A}			0.0187		Anode side cooled
R_{thjc-K}			0.0153		Cathode side cooled
R_{thck}	Thermal resistance, case to heatsink, max	°C/W	0.0020	Direct current	
MECHANICAL					
w	Weight, typ	g	1500		
D_s	Surface creepage distance	mm (inch)	36.60 (1.441)		
D_a	Air strike distance	mm (inch)	16.20 (0.638)		

Beijing Xinchuang Chunshu Rectifier Co., Ltd

OVERALL DIMENSIONS



KT80

All dimensions in millimeters

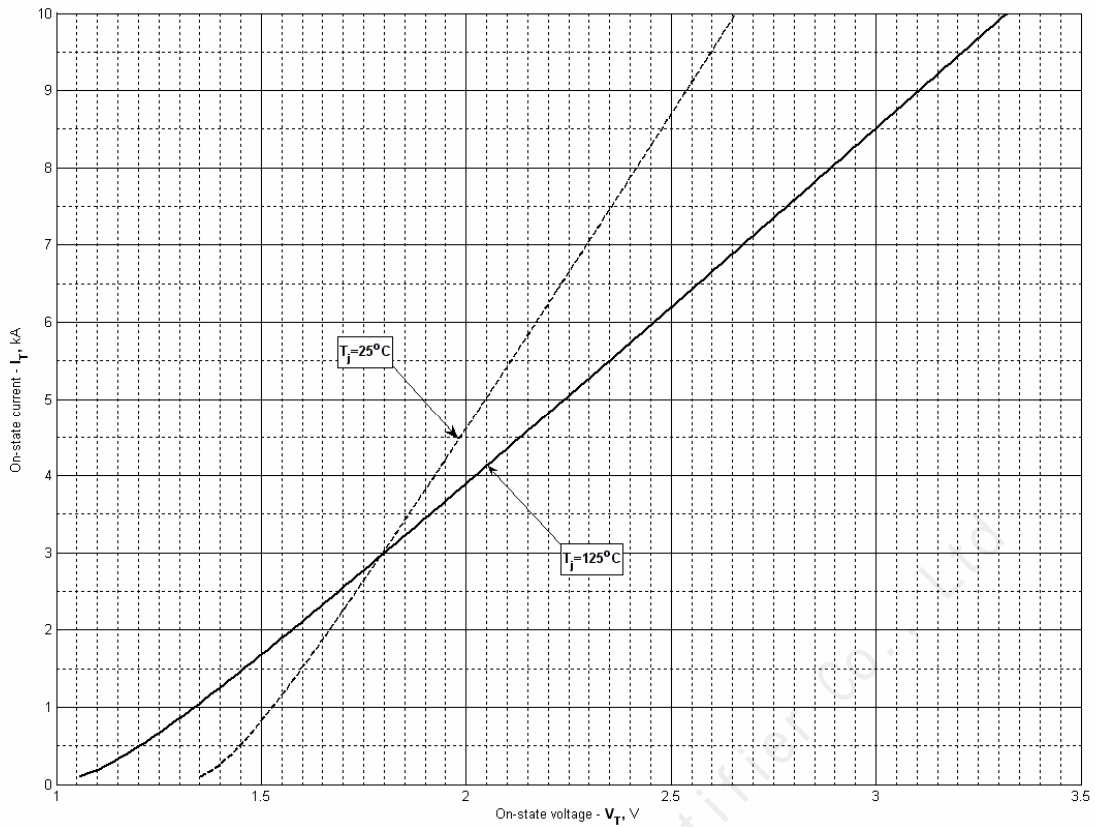


Fig 1 – On-state characteristics of Limit device

Analytical function for On-state characteristic:

$$V_T = A + B \cdot i_T + C \cdot \ln(i_T + 1) + D \cdot \sqrt{i_T}$$

	Coefficients for max curves	
	$T_j = 25^\circ\text{C}$	$T_j = T_{j \max}$
A	1.259909	0.927342
B	0.086589	0.168048
C	-0.206887	-0.276312
D	0.324522	0.433423

On-state characteristic model (see Fig. 1)

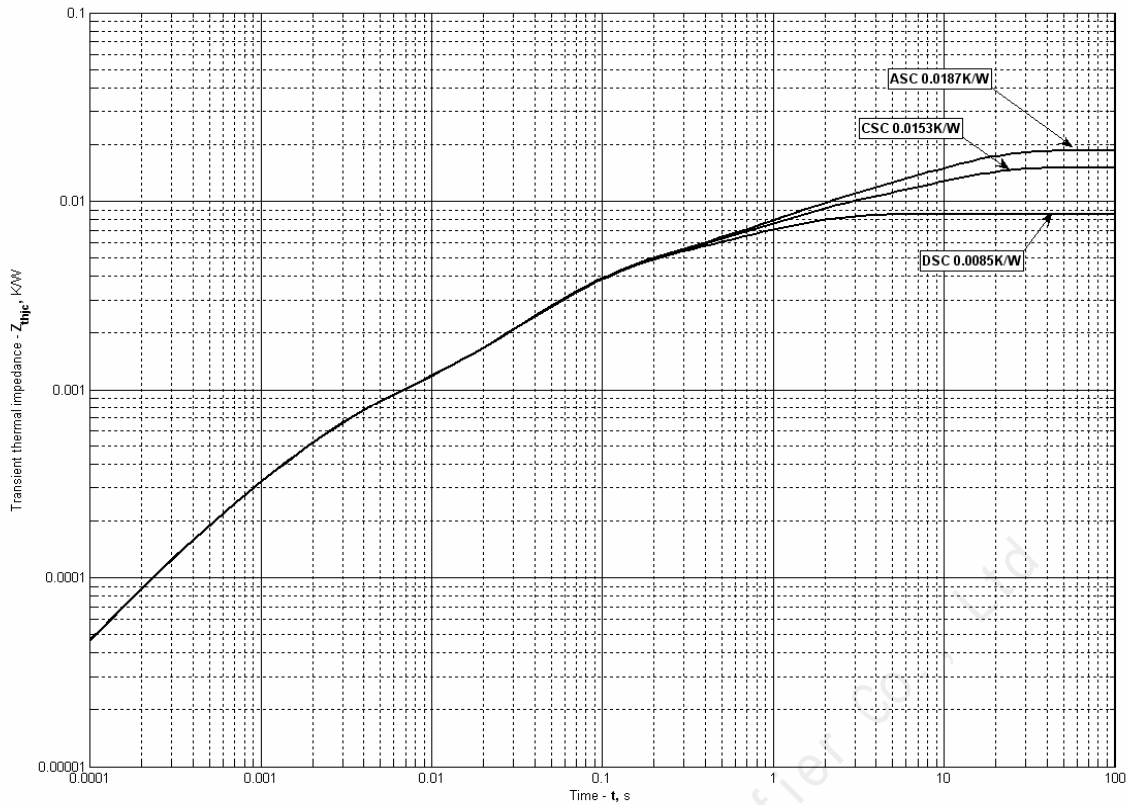


Fig 2 – Transient thermal impedance

Analytical function for Transient thermal impedance junction to case Z_{thjc} for DC:

$$Z_{thjc} = \sum_{i=1}^n R_i \left(1 - e^{-\frac{t}{\tau_i}} \right)$$

Where $i = 1$ to n , n is the number of terms in the series.

t = Duration of heating pulse in seconds.

Z_{thjc} = Thermal resistance at time t .

R_i = Amplitude of p_{th} term.

τ_i = Time constant of r_{th} term.

DC Double side cooled

i	1	2	3	4	5	6
R_i , K/W	0.00007989	0.002973	0.0005936	0.000846	0.00005975	0.003948
τ_i , s	1.688	0.06219	0.002329	0.138	0.0003243	0.9533

DC Anode side cooled

i	1	2	3	4	5	6
R_i , K/W	0.01013	0.004062	0.0009401	0.002853	0.0005963	0.00005641
τ_i , s	9.747	1.058	0.1304	0.06179	0.002313	0.0003013

DC Cathode side cooled

i	1	2	3	4	5	6
R_i , K/W	0.006619	0.004034	0.0008595	0.002956	0.0005965	0.00005689
τ_i , s	9.744	1.025	0.1394	0.06237	0.002318	0.0003037

Transient thermal impedance junction to case Z_{thjc} model (see Fig. 2)

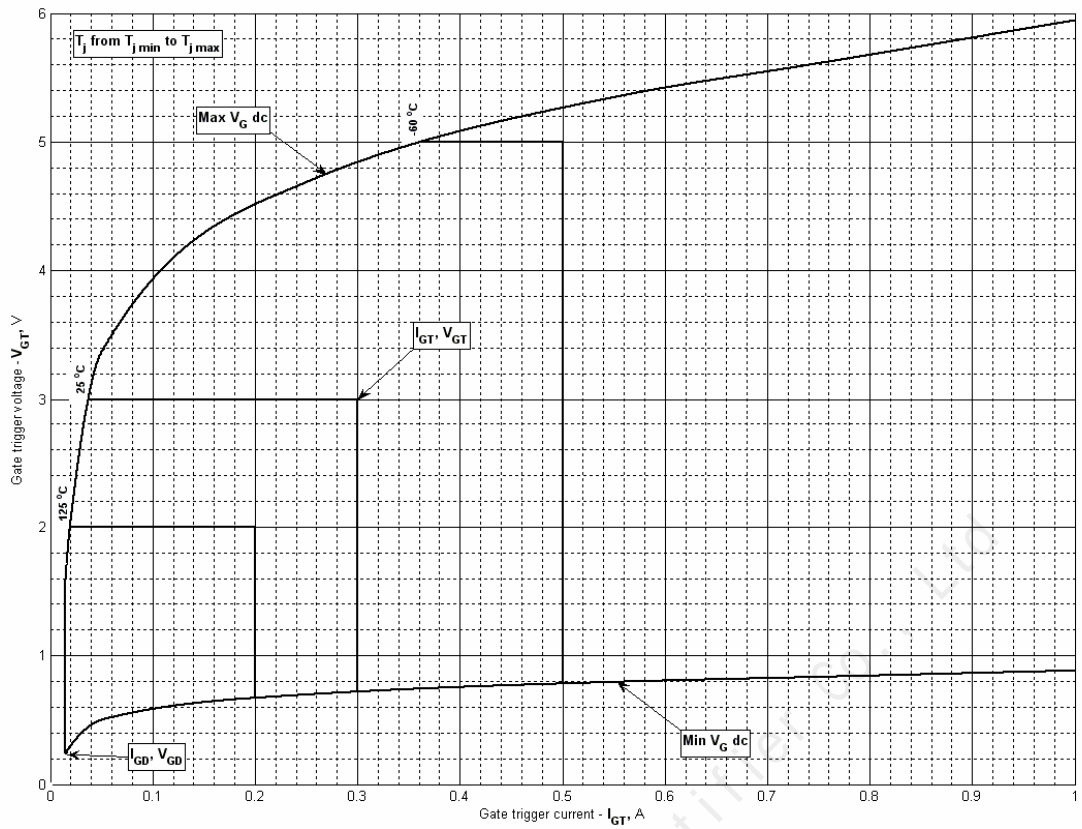


Fig 3 – Gate characteristics – Trigger limits

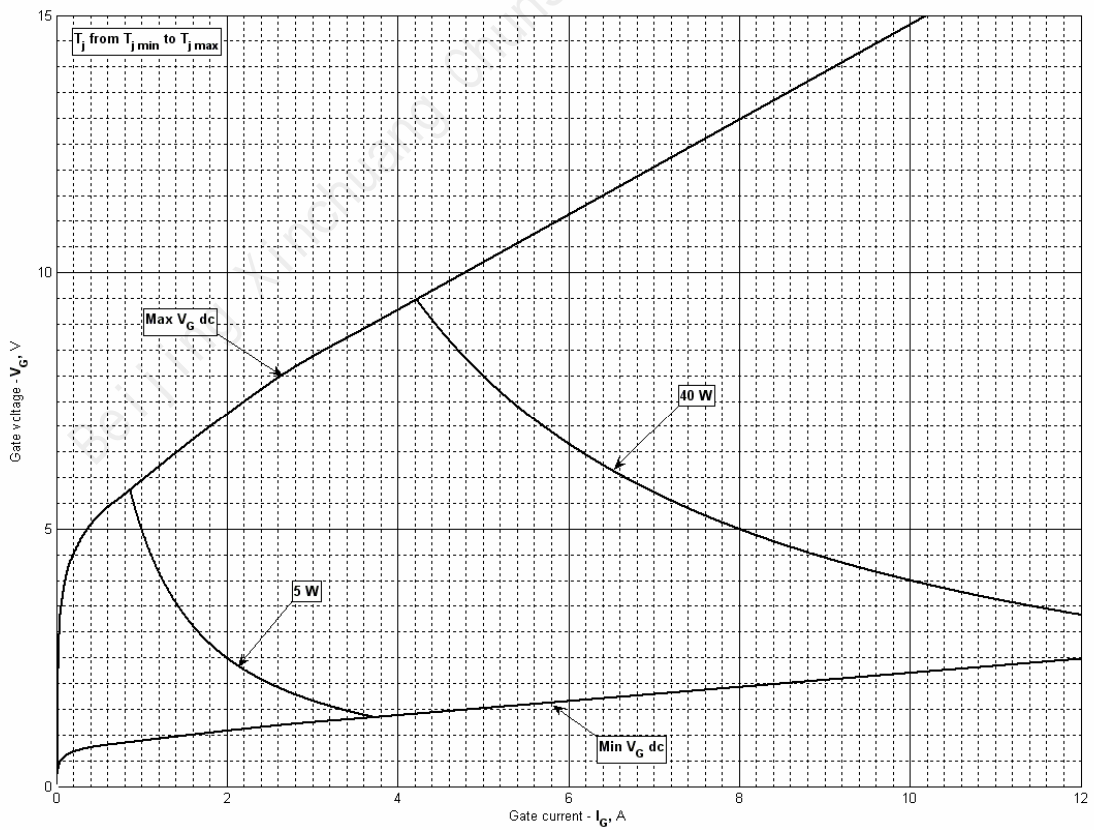


Fig 4 - Gate characteristics – Power curves

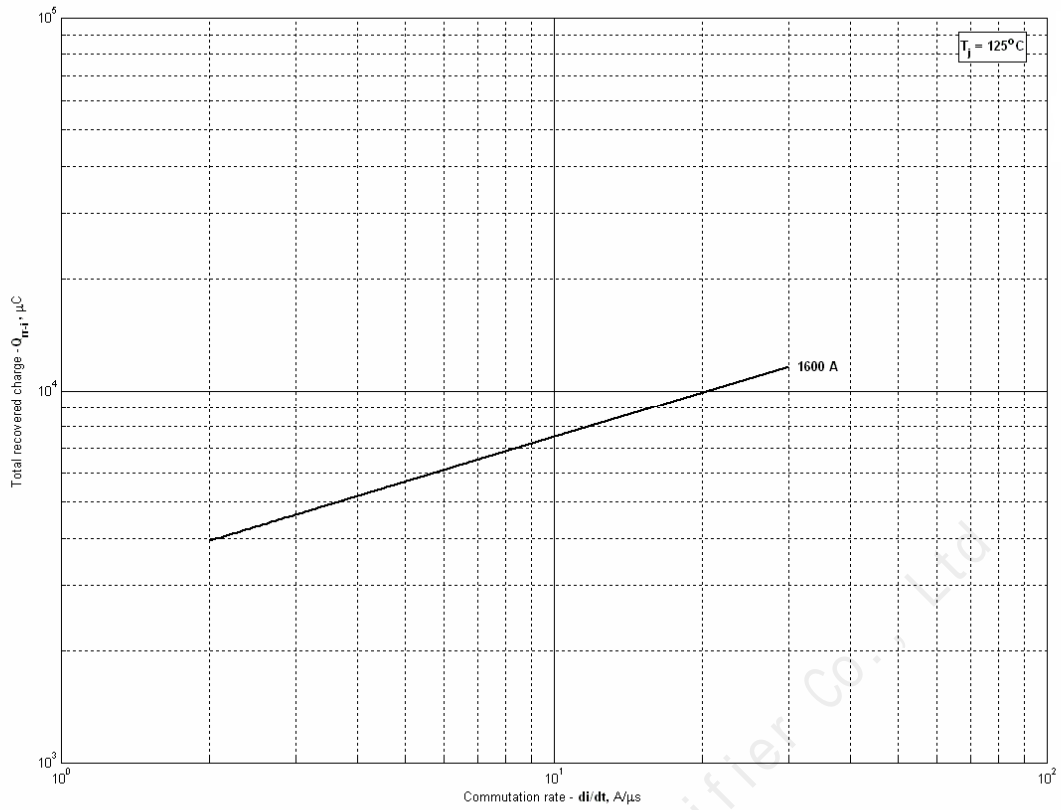


Fig 5 – Total recovered charge, Q_{rr-i} (integral)

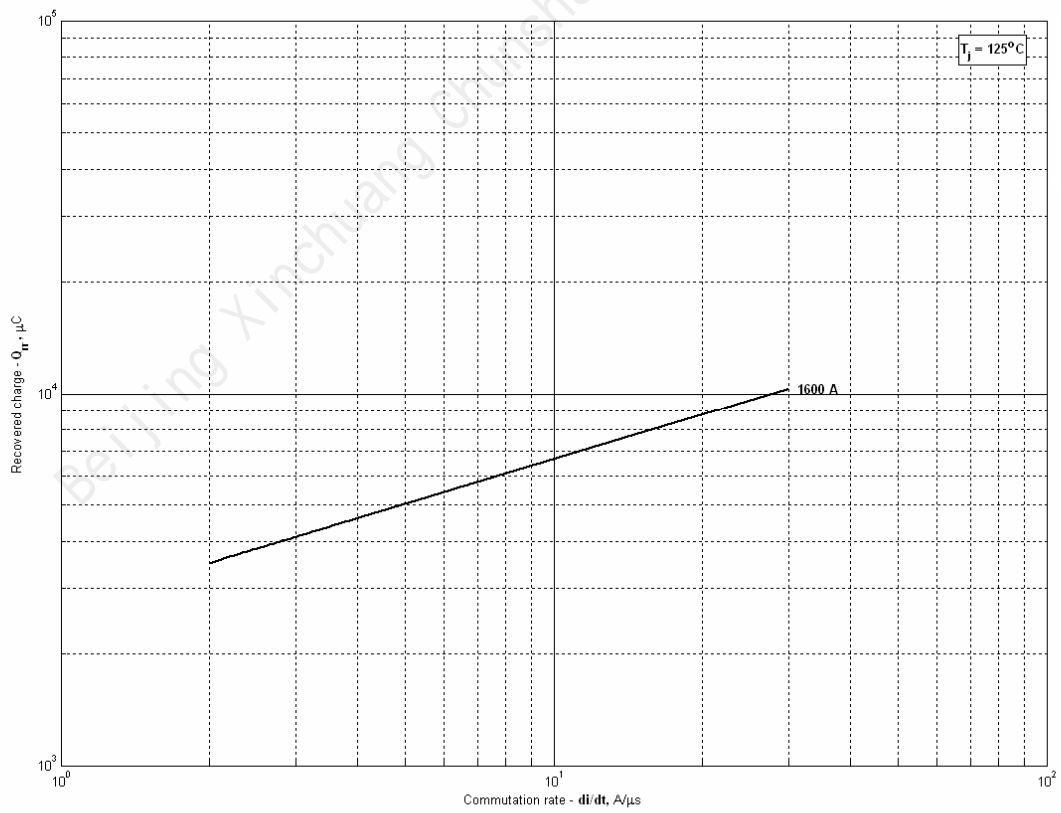


Fig 6 - Recovered charge, Q_{rr} (linear)

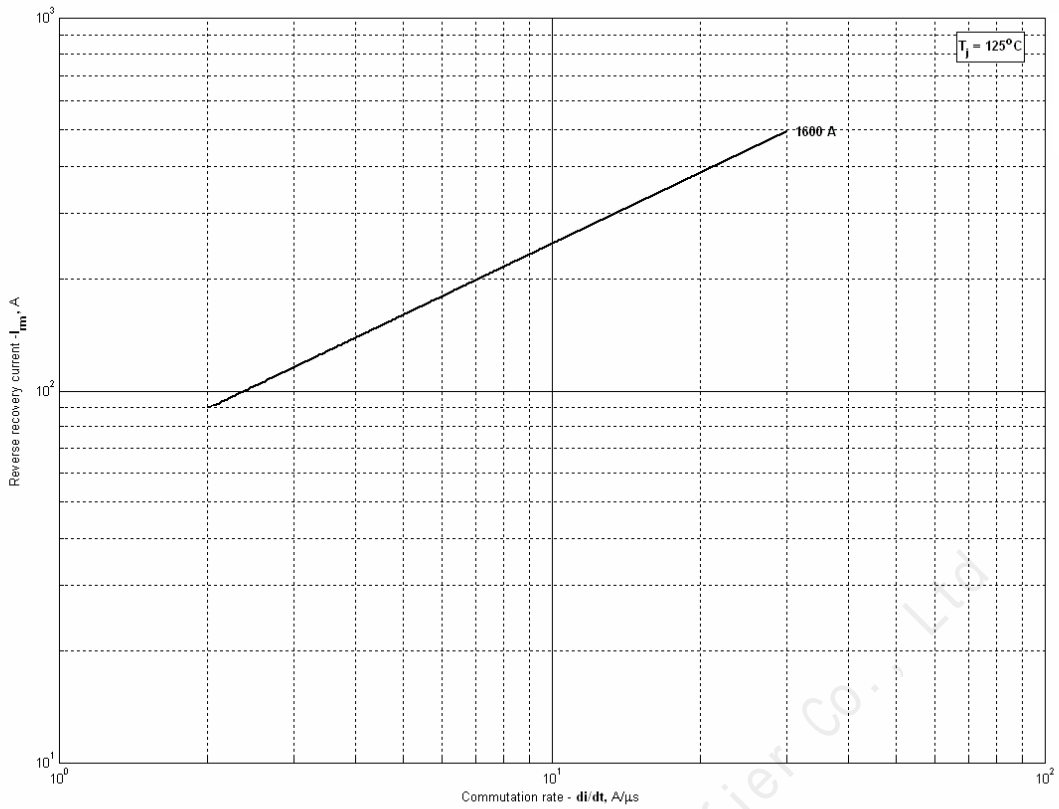


Fig 7 – Peak reverse recovery current, I_{fm}

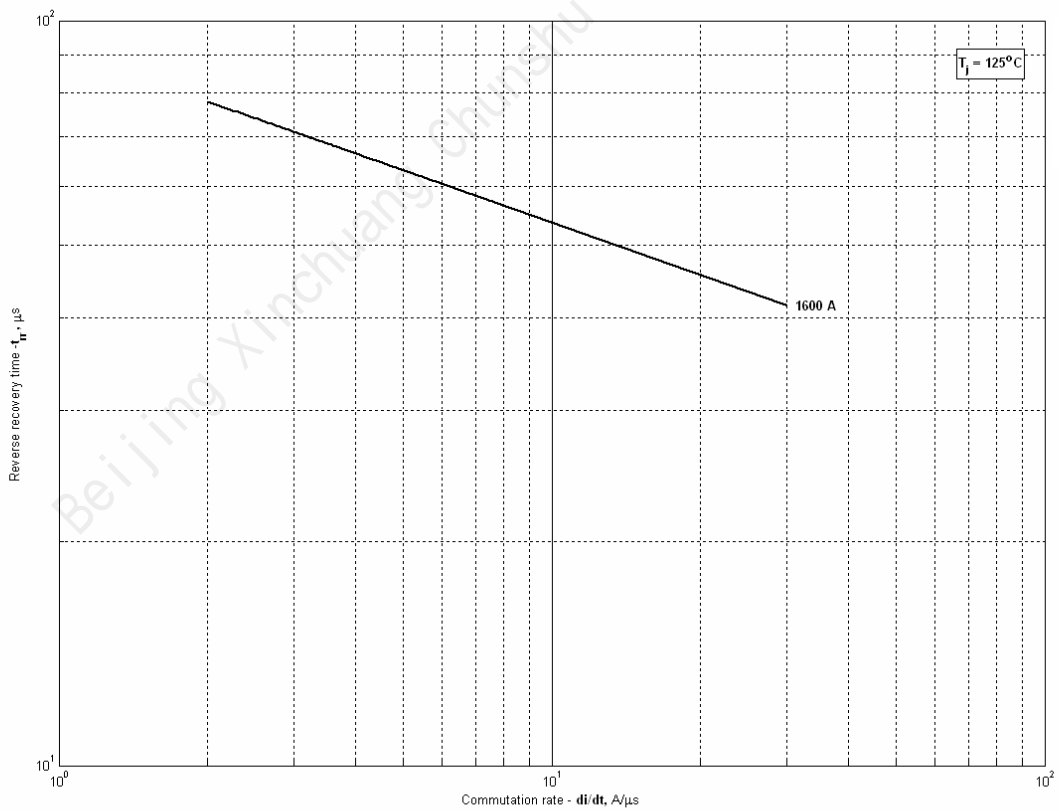


Fig 8 – Maximum recovery time, t_{rr} (linear)

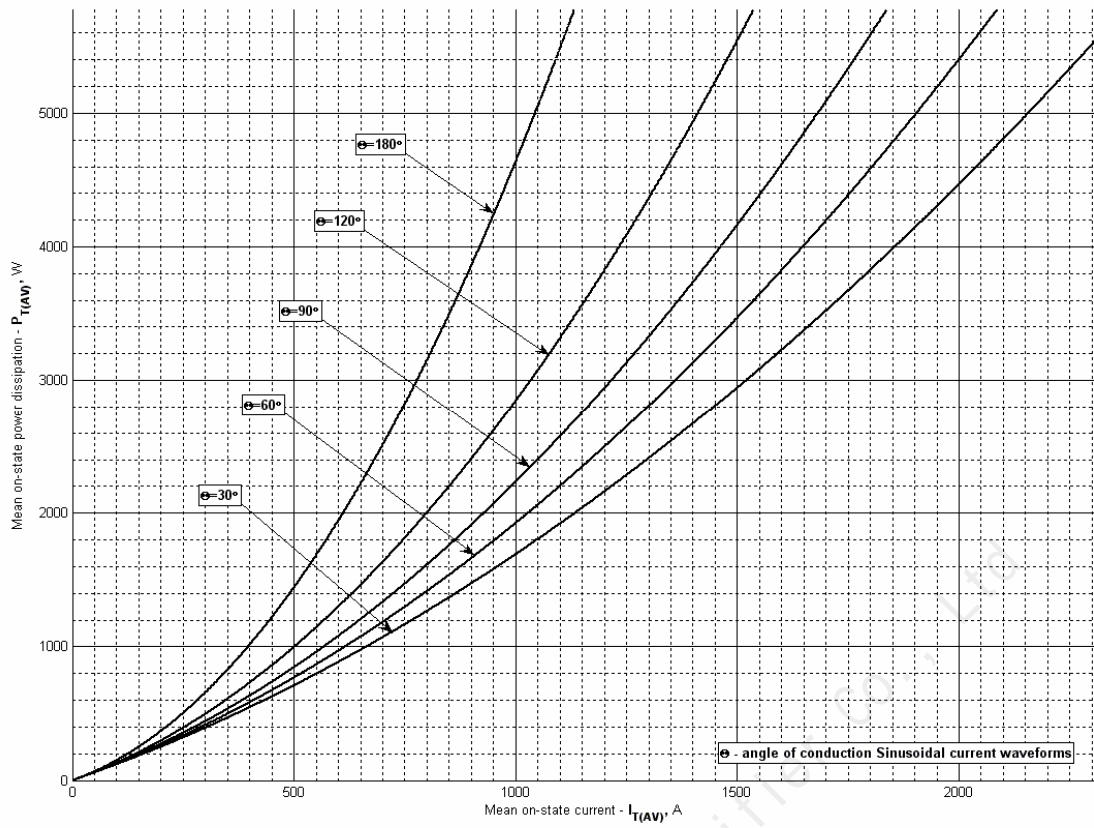


Fig 9 – On-state power loss (sinusoidal current waveforms)

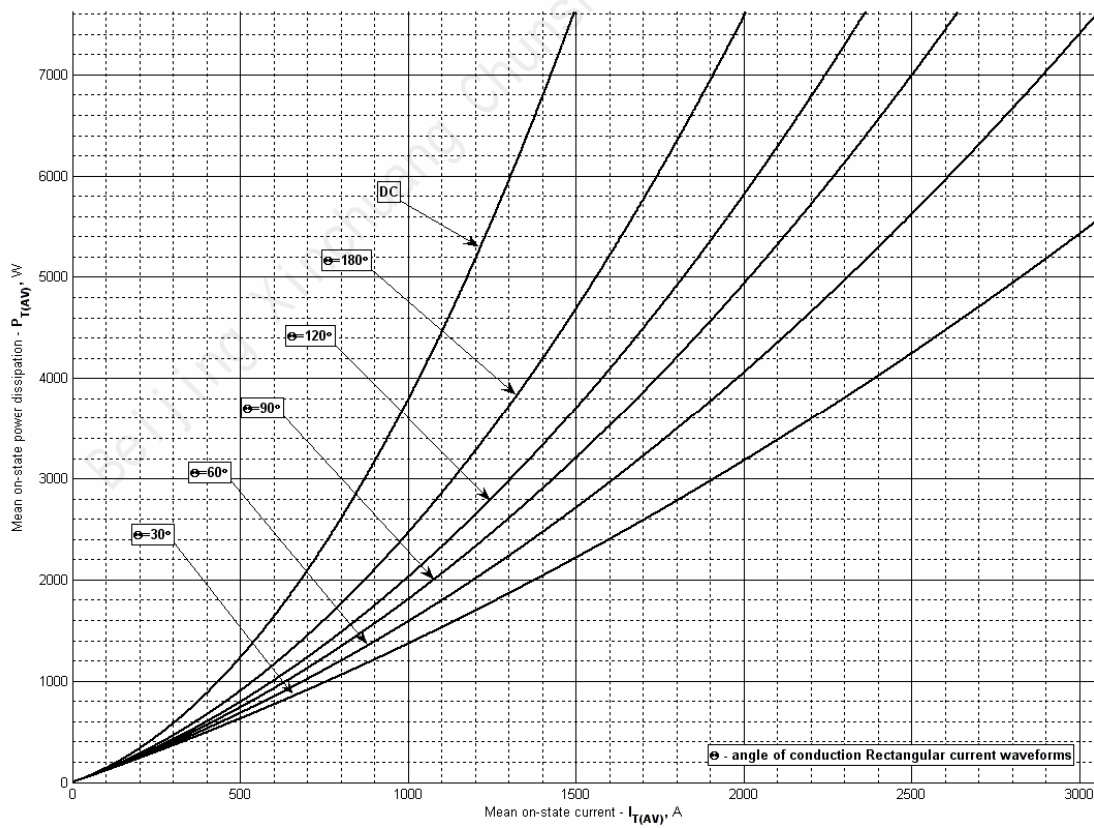


Fig 10 – On-state power loss (rectangular current waveforms)

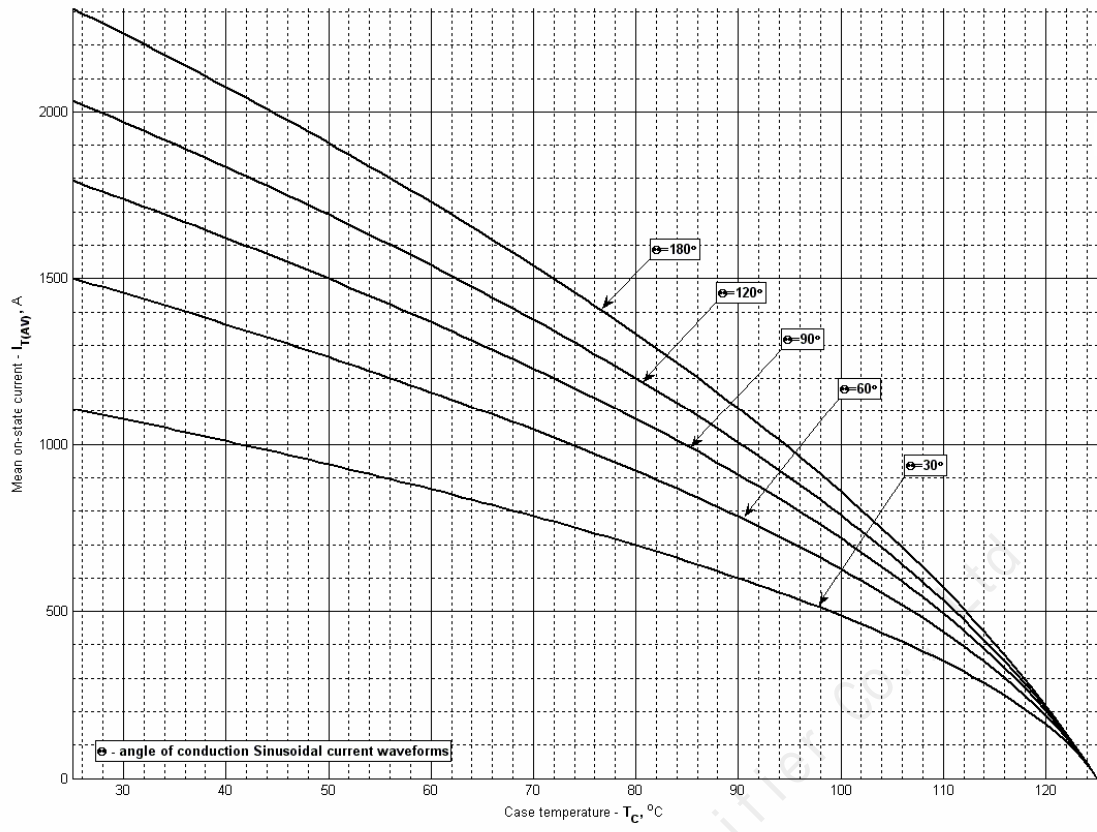


Fig 11 – Maximum case temperature DSC (sinusoidal current waveforms)

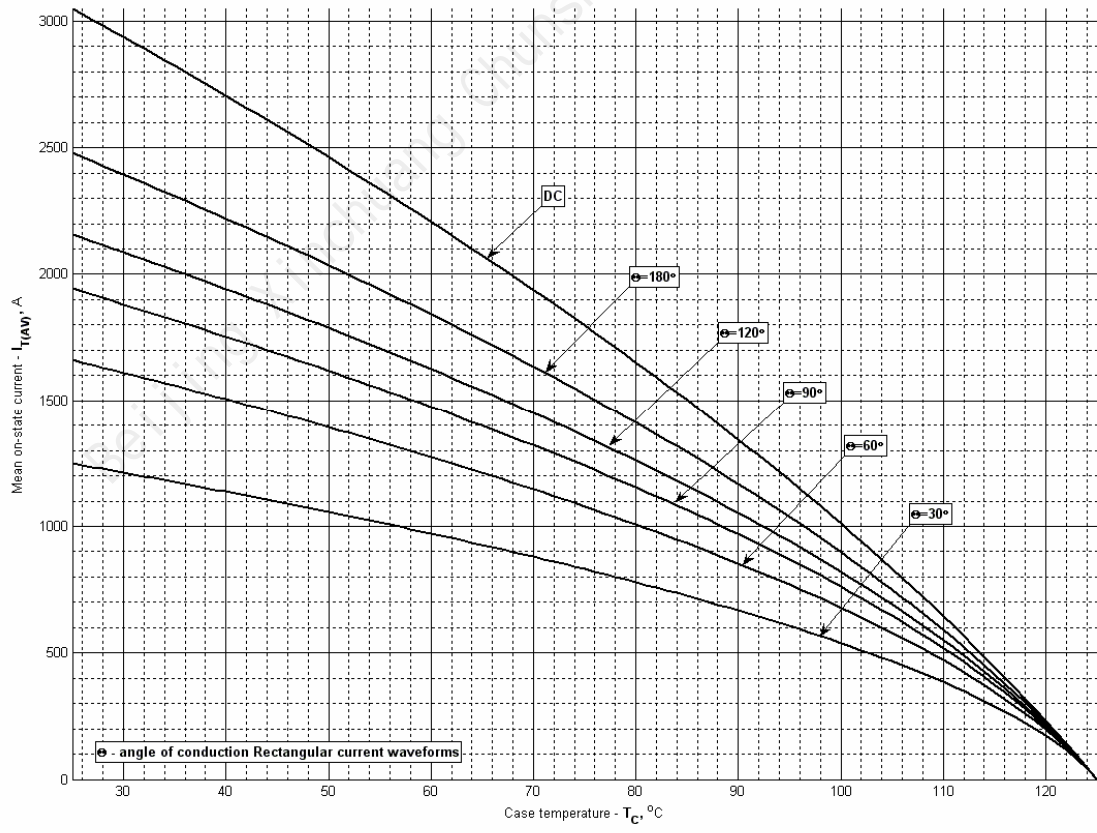


Fig 12 – Maximum case temperature DSC (rectangular current waveforms)

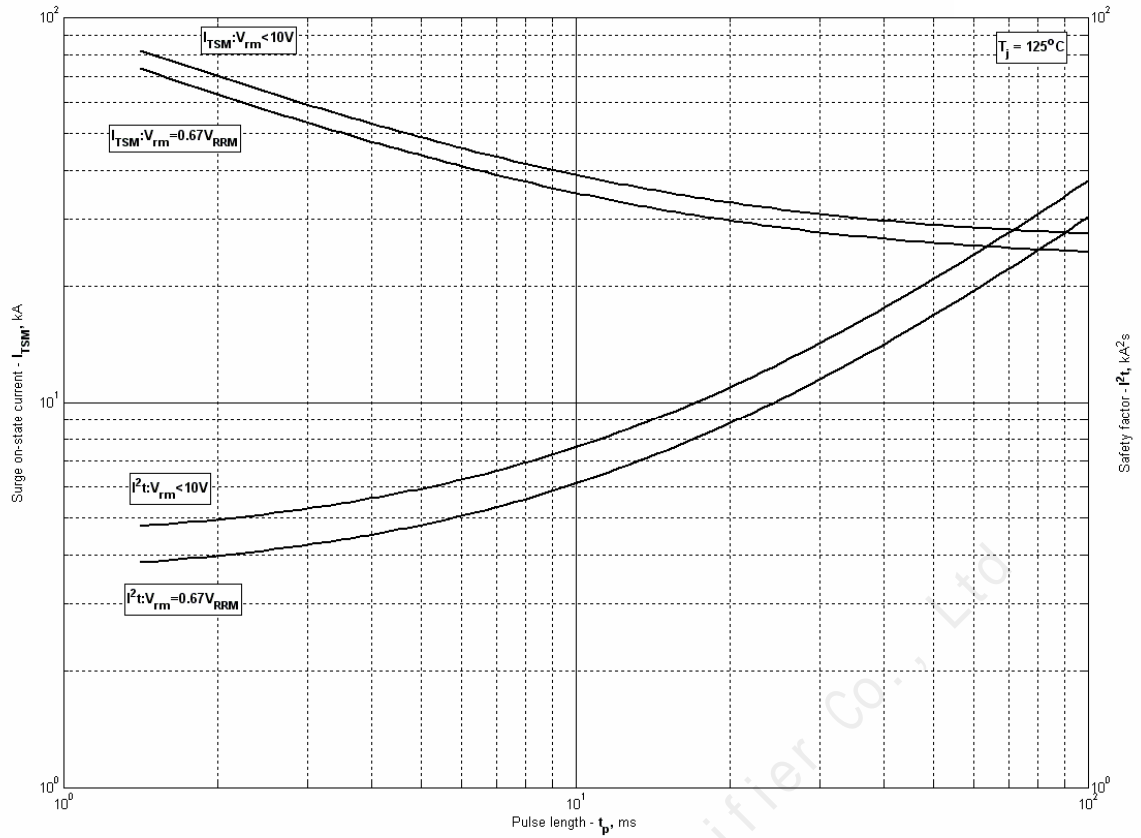


Fig 13 – Maximum surge and I^2t ratings

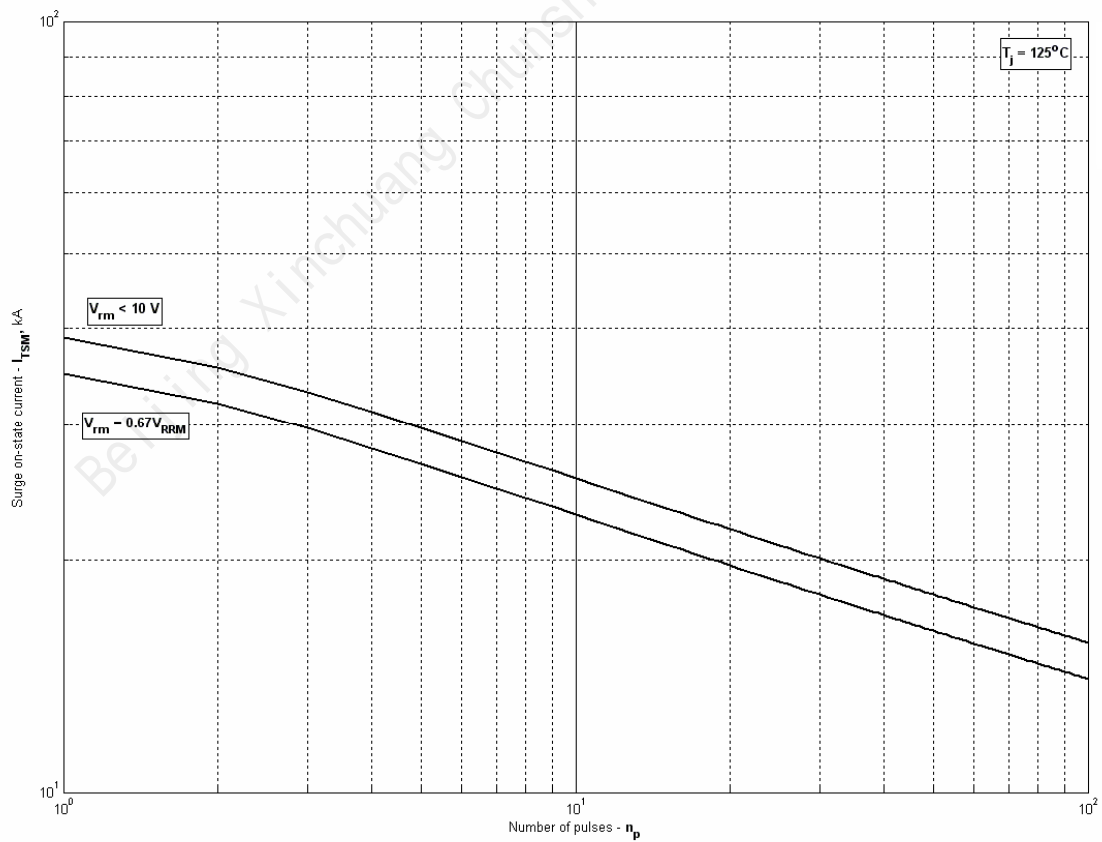


Fig 14 – Maximum surge ratings